

SANYO Semiconductors **DATA SHEET**

LA75520KVA—

Monolithic Linear IC

IF Signal Processing (VIF+SIF) IC that Supports the PAL Video Standard for TV Sets and VCRs

Overview

The LA75520KVA is a fully adjustment-free VIF + SIF signal processing IC for TV sets and VTRs that supports the PAL video standard. It supports 38.0MHz, 38.9MHz, and 39.5MHz as the IF frequencies, as well as PAL sound multi-system (M/N, B/G, I and D/K), and contains an on-chip sound carrier trap. The IC employs a 4MHz frequency (which can be switched to 4.43MHz) as the reference frequency of the adjustment free circuit, and controls the VCO, AFT, and sound filter using an external input signal.

Features

- Internal VCO adjustment free circuit eliminating the need for an external VCO coil.
- Internal sound carrier trap enables easy configuration of PAL sound multi-system at low cost.
- Considerably reduces the number of required peripheral parts.
- Use of digital AFT eliminates a problem of AFT tolerance.
- Package: SSOP24 (225mil)

Functions

- VIF amplifier
- Adjustment-free VCO and PLL detector circuit
- Digital AFT circuit
- RF AGC
- Buzz canceller

- EQAMP
- Internal sound carrier trap
- First SIF detector circuit
- PLL-FM detector circuit

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Specifications

Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	Vcc		6	V
Allowable power dissipation	Pd max	Ta ≤ 70°C, Mounted on a substrate.*	640	mW
Operating temperature	Topr		-20 to +70	°C
Storage temperature	Tstg		-55 to +150	°C

^{*} Mounted on a substrate : $76.1 \times 114.3 \times 1.6 \text{mm}^3$, glass epoxy board.

Operating Conditions at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Recommended supply voltage	Vcc		5.0	V
Operating supply voltage	V _{CC} op		4.5 to 5.5	V

Electrical Characteristics at Ta = 25°C, $V_{CC} = 5.0V$, fp = 38.9MHz

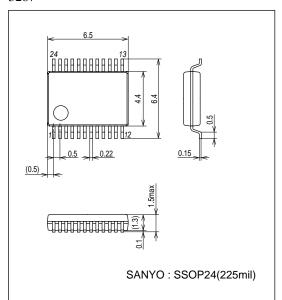
Doromotor	Symbol	Conditions	No		Ratings		Unit
Parameter	Symbol	Conditions	No.	min	typ	max	Unit
VIF block							
Circuit current	14		V1	75	85	95	mA
Max RF AGC voltage	V ₁₄ H		V2	4.0	4.5	5.0	>
Min RF AGC voltage	V ₁₄ L		V3	0.0	0.5	1.0	V
Input sensitivity	V _i	Video out 2	V4	26	32	38	dΒμV
AGC range	GR		V5	58	63		dB
Max allowable input	V _i max		V6	95	100		dΒμV
Quiescent video output voltage	V ₅		V7	2.2	2.5	2.8	V
Sync signal edge voltage	V ₅ tip		V8	0.8	1.0	1.2	V
Video output level	Vo		V9	1.0	1.2	1.4	Vp-p
Black noise threshold voltage	V _{BTH}		V10	0.5	0.8	1.1	V
Black noise clamp voltage	V _{BCL}		V11	1.2	1.5	1.8	V
Video S/N	S/N	B/G	V12	46	50		dB
C-S best	IC-S	P/S = 10dB	V13	38	43		dB
Differential gain	DG	$V_{IN} = 80 dB\mu$	V14		3	6.5	%
Differential phase	DP		V15		3	5	deg
Quiescent AFT voltage	V ₁₂	15pin to V _{CC}	V16	2.0	2.5	3.0	٧
Max AFT voltage	V ₁₂ H	LOAD 22kΩ/22kΩ	V17	4	4.5	5	V
Min AFT voltage	V ₁₂ L	LOAD 22kΩ/22kΩ	V18	0	0.5	1	٧
AFT sensitivity	SF	LOAD 22kΩ/22kΩ	V19	8.5	12.5	16.5	mV/kHz
APC pull-in range (U)	Fpu		V20	2.0	2.4		MHz
APC pull-in range (L)	Fpl		V21		-2.4	-2.0	MHz
VCO control sensitivity	β		V22	3	6	12	kHz/mV
VIF input resistance	Ri	38.9MHz	V23		1.0	1.5	kΩ
VIF input capacity	C _i	38.9MHz	V24		3	6	pF
N trap1 (4.5M)	NT1	wrt 1MHz	V25	-30	-35		dB
N trap2 (4.8M)	NT2	wrt 1MHz	V26	-19	-24		dB
BG trap1 (5.5M)	BT1	wrt 1MHz	V27	-27	-32		dB
BG trap2 (5.85M)	BT2	wrt 1MHz	V28	-20	-25		dB
I trap1 (6.0M)	IT1	wrt 1MHz	V29	-25	-30		dB
I trap2 (6.55M)	IT2	wrt 1MHz	V30	-15	-20		dB
DK trap1 (6.5M)	DT1	wrt 1MHz	V31	-25	-30		dB
Group delay 1 NTSC (3.0M)	NGD1	wrt 1MHz	V32	30	80	145	ns
Group delay 1-1 NTSC (3.5M)	NGD1-1	wrt 1MHz	V33	110	200	290	ns
Group delay 2 BG (4M)	BGD2	wrt 1MHz	V34	50	130	210	ns
Group delay 2-1 BG (4.4M)	BGD2-1	wrt 1MHz	V35	120	200	280	ns
Group delay 3 I (4M)	IGD3	wrt 1MHz	V36	0	80	130	ns

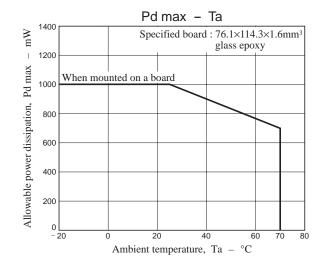
Parameter	Symbol	Conditions	No.		Ratings		Unit
i aiaiiicici	Gyillion	Contaitions	INO.	min	typ	max	Oliit
Group delay 3-1 I (4.4M)	IGD3-1	wrt 1MHz	V37	80	120	160	ns
Group delay 4 DK (4M)	DGD4	wrt 1MHz	V38	10	30	50	ns
Group delay 4-1 DK (4.4M)	DGD4-1	wrt 1MHz	V39	30	60	90	ns
Video f characteristics MN1	VFMN1	M/N 1 to 2MHz	V40	-1.0	0.0	1.0	dB
Video f characteristics MN2	VFMN2	M/N 2 to 3MHz	V41	-1.0	0.0	1.0	dB
Video f characteristics MN3	VFMN3	M/N 3.58MHz	V42	-3.0	-1.5	0.0	dB
Video f characteristics BG1	VFBG1	B/G 1 to 3MHz	V43	-1.0	0.0	1.5	dB
Video f characteristics BG2	VFBG2	B/G 3 to 4MHz	V44	-1.5	0.0	1.5	dB
Video f characteristics BG3	VFBG3	B/G 4.43MHz	V45	-2.5	-1.0	0.5	dB
Video f characteristics I1	VFI1	I 1 to 3MHz	V46	-1.0	0.0	1.0	dB
Video f characteristics I2	VFI2	I 3 to 4MHz	V47	-1.0	0.0	1.5	dB
Video f characteristics I3	VFI3	I 4.43MHz	V48	-1.5	0.0	1.5	dB
Video f characteristics DK1	VFDK1	D/K 1 to 3MHz	V49	-1.0	0.0	1.0	dB
Video f characteristics DK2	VFDK2	D/K 3 to 4MHz	V50	-1.0	0.0	1.5	dB
Video f characteristics DK3	VFDK3	D/K 4.43MHz	V51	-1.5	0.0	1.5	dB
Group delay 2-2 BG shift (4M)	BGD2-2	wrt 1MHz	V52	50	100	150	ns
Group delay 2-3 BG shift (4.4M)	BGD2-3	wrt 1MHz	V53	110	180	250	ns
1st SIF Block	I.	<u>l</u>				Į.	
SIF carrier output level 1	So1	V _i = 1mV	F1	21	43	86	mVrms
SIF carrier output level 2	So2	V _i = 10mV	F2	21	43	86	mVrms
1st SIF max input	Si max	1 12	F3	110	120		dΒμV
1st SIF input resistance	Ris	33.4MHz	F4		2	2.4	kΩ
1st SIF input capacity	Cis	33.4MHz	F5		3	6	pF
SIF Block	0.0	00.11112	1.0		ŭ	ŭ	Pi
Limiting sensitivity (SPLIT)	V _i (lim) (SP)	P = 80dBμ CW	S1	20	25	30	dΒμV
Limiting sensitivity (INTER)	V _i (lim) (IN)	P = 80dBμ P/S	S2	29	35	41	dΒ
FM detection output voltage	<u> </u>	$f = 5.5MHz$, $\Delta F = \pm 30kHz$	S3	390	560	730	mVrms
AM removal ratio	V _O (FM) AMR	1 = 5.5WΠ2, ΔΓ = ±50KΠ2	S4	50	60	730	dB
	THD			50		0.0	ив %
Distortion factor		D 00-ID: OW	S5		0.3	0.8	
FM detection output S/N	S/N (FM)	P = 80dBμ CW	S6	55	60		dB
PAL/NT audio voltage gain difference	GD		S7		6		dB
PAL De-emphasis	Pdeem		S8		-3		dB
NT De-emphasis	Ndeem		S9		-3		dB
Control Block	l v= au		1 01 1				
SIF system SW threshold voltage A/B	V7_9th		C1	2.2	2.5	2.8	V
38MHz/38.9MHz threshold voltage	V10th1		C2	0.7	1.0	1.3	V
38.9MHz/39.5MHz threshold voltage	V10th2		C3	3.7	4.0	4.3	V
Inter-carrier system	V13th		C4			0.3	V
AFT mute level/SIF trap shift	V15th1		C5	0.7	1.0	1.3	V
threshold voltage 1 AFT mute level/SIF trap shift	V15th2		C6	2.2	2.5	2.8	V
threshold voltage 2	V IOUIZ			۷.۷	2.0	2.0	V
AFT mute level/SIF trap shift	V15th3		C7	3.7	4.0	4.3	V
threshold voltage 3							
Others							
Ref clock input level	Reflev	4.0MHz	01	83	90	95	dBμV
Reference frequency SW threshold	R11		O2	150	270		kΩ
resistance							

Package Dimensions

unit: mm (typ)

3287





System changeover

a. SIF system SW

The SIF system can be changed over by setting A (pin 7) and B (pin 9) to GND and OPEN respectively.

А	В	BG	1	DK	MN	FM DET LEVEL	De-emphasis
GND	GND				0	6dB	75μs
GND	OPEN			0		0dB	50μs
OPEN	GND		0			0dB	50μs
OPEN	OPEN	0				0dB	50μs

Note: Circles mean that the system indicated with a circle is selected

b. IF system SW

The IF frequency becomes 38.9MHz when pin 10 is open.

The IF frequency becomes 38.0MHz when pin 10 is set to GND.

The IF frequency becomes 39.5MHz when pin 10 is set to V_{CC}.

c. Split/inter carrier SW

Inter-carrier is selected by setting the 1st SIF input (pin 13) to GND.

d. Reference frequency changeover SW

The reference frequency becomes 4.43MHz when pin 11 is OPEN.

The reference frequency becomes 4.0 MHz when $270 \text{k}\Omega$ is connected between pin 11 and GND.

e. AFT mute level, trap point shift SW

By changing the pin 15 voltage, the potential and TRAP point at which AFT is muted can be set to either just or shift (about +220kHz).

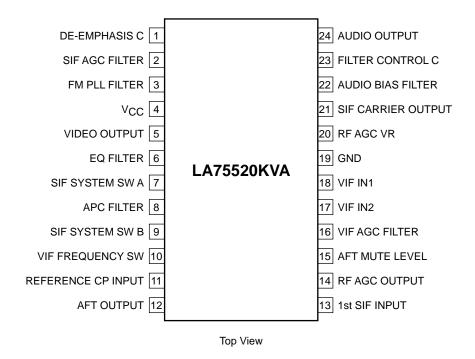
Pin 15 potential	AFT mute potential	TRAP point shift
V _{CC} to 4V	MIDDLE (V _{CC} /2)	Just
4V to 2.5V	MIDDLE (V _{CC} /2)	Shift
2.5V to 1V	HI (V _{CC})	Just
1V to GND	HI (V _{CC})	Shift

^{*} V_{CC}=5V

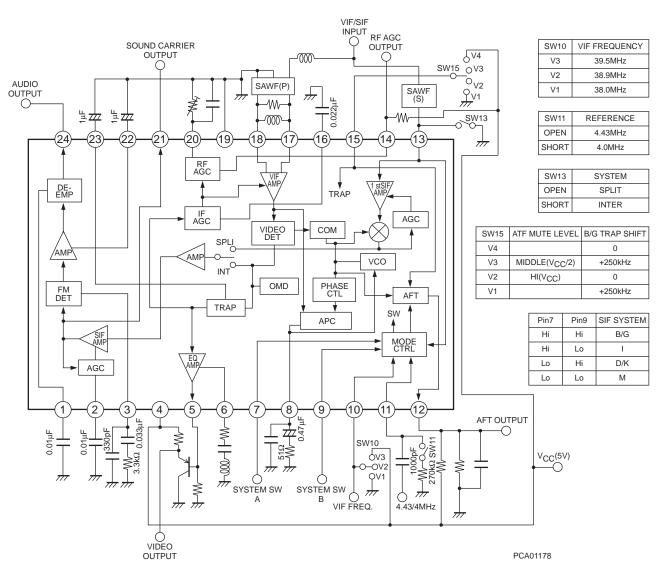
f. FM detector function not used

To stop FM detection VCO without using the SIF circuit, short-circuit pin 1-GND with resistance of $1k\Omega$ or less.

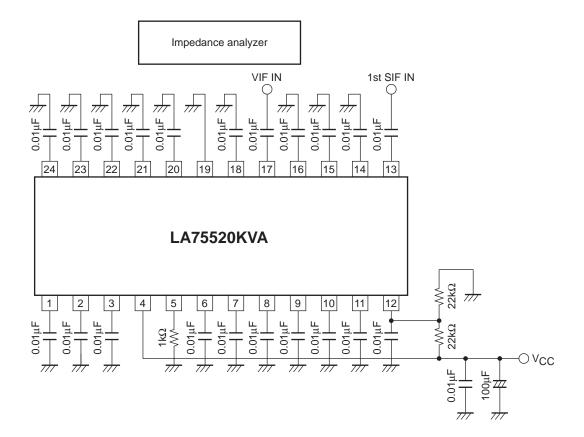
Pin Assignment



Block Diagram and Sample Application



Input Impedance Test Circuit (VIF and first SIF input impedance)



Pin Functions

1 111 1 0	inctions	T	
Pin No.	Pin name	Function	Equivalent Circuit
1	DE-EMPHASIS C	De-emphasis capacitor connection pin This is used to switch the equivalent resistance $(5k\Omega \ or \ 7.5k\Omega)$ internally in the IC to select the time constant. This switching is linked to the SIF input switch. To disable de-emphasis, disconnect the capacitor. Connection of an external capacitance of $0.01\mu F$ enables switching between 50 and $75\mu s$. When the FM detector circuit is not to be used, the FM VCO can be stopped by connecting it to ground with a resistor of $1k\Omega$ or less.	0.01μF 777 777 777 777 777 777 777 777 777 7
2	SIF AGC FILTER	AGC filter pin for SIF carrier 0.01μF is recommended for C1.	2 2kΩ W M M
3	FM PLL FILTER	PLL filter pin of FM detector This is used to configure an external lag lead filter. Example: Connect 330pF in parallel with the filter on the left $(0.033\mu\text{F} + 3.3k\Omega)$.	3 3 3
5 6	VCC EQ OUT EQ FILTER	 Power supply Equalizer circuit. This circuit is used to correct the video signal frequency characteristics. Notes on equalizer amplifier design The equalizer amplifier is designed as a voltage follower amplifier with a gain of about 0 dB. When used for frequency characteristics correction, a capacitor, inductor, and resistor must be connected in series between pin 6 and ground. Equalizer amplifier gain AV = R1/Z + 1 R1 is the IC internal resistance, and is 1kΩ. In the application design, simply select Z to correspond to the desired characteristics. However, since the 	2kΩ R1:1kΩ 5
		EQ amplifier gain will be maximum at the resonant point defined by Z, care is required to assure that distortion does not occur.	TC Z

Continued for	ware was as dim a was a			
Pin No.	rom preceding page.	En	ınction	Equivalent Circuit
	Pin name			Equivalent Circuit
9	SIF SYSTEM SW A	settings of these two pir In M/N mode, the audio 6dB.	witch pins. Combining the his supports four systems. output level is increased by linked to these switches. follows. MODE B/G I D/K M/N	30kΩ 80kΩ 1kΩ 1kΩ 50kΩ 1kΩ 50kΩ 1kΩ 50kΩ 1kΩ 50kΩ 1kΩ 50kΩ 1kΩ 1kΩ 50kΩ 50kΩ 1kΩ 50k
8	APC FILTER	switched internally in the The VCO is normally co When unlocked and dur VCO is controlled by rou increased. For this APC filter we re and capacitor of 0.47µF The buzz characteristics	entrolled by route A. ing weak field reception, the ute B and the loop gain is ecommend a resistor of 51Ω	A DET WYWW IKΩ IKΩ IKΩ
10	VIF FREQUENCY SW	Switch pin for selecting When this pin is open, 1 VCC: 39.5MHz Open: 38.9MHz GND: 38.0MHz		\$50kΩ 11kΩ \$50kΩ
11	REFERENCE CP INPUT	the internal sound carrie Either 4.0 or 4.43 MHz of configuration shown in a 4.43MHz and configurati when using 4.0MHz. Since no oscillator can be connecting the X'tal res- reference signal from an fail.	can be selected. Use the example 1 when using tion shown in example 2	

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Pin No.	Pin name	Function	Equivalent Circuit			
12	AFT OUTPUT	AFT output pin. The AFT center voltage is generated by an external bleeder resistor. The AFT gain is increased by increasing the resistance of this external bleeder resistor. For the resistor we recommend a resistance equal to or greater than 22k Ω . For the filter C1 we recommend a capacitance of 0.1 μ F.	12 R R R R R R R R R R R R R R R R R R R			
13	1st SIF INPUT	First SIF input pin. A DC cut capacitor must be used in the input circuit. (a) If a SAW filter is used: The first SIF sensitivity can be increased by inserting an inductor between the SAW filter and the IC to neutralize the SAW filter output capacitance and the IC input capacitance. (b) When used in an intercarrier system: Connect this pin to ground.	2κΩ 			
14	RF AGC OUTPUT	RF AGC output pin. This output controls the tuner RF AGC. This is the open collector output and a protective 200Ω resistor is inserted. Determine the external bleeder resistor value in accordance with the specifications of the tuner.	VCC 200Ω 14 200Ω mm mm			
15	AFT MUTE LEVEL	A switch pin for selecting the mute potential when muting is applied to the AFT due to PLL unlock, etc. At the same time, it is used to control the trap point shift of the audio trap (in the B/G mode). When the frequency characteristics of the video band are to be made as flat as possible with the split input, the trap can be shifted to the high range although the attenuation of the sound carrier will drop. Therefore, when used in combination with the SAW filter, verify that the level is high enough before use. Voltage	\$66kΩ 15 \$34kΩ			

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Pin No.	Pin name	Function	Equivalent Circuit
16	IF AGC	IF AGC filter connection pin. The signal peak-detected by the built-in AGC detector is converted to the AGC voltage at pin 16. Additionally, a second AGC filter (a lag-lead filter) used to create the dual time constants is provided internally in the IC. Use a 0.022µF capacitor as the external capacitor (C1), and adjust the value according to the sag, AGC speed, and other characteristics.	16
17 18	VIF IN1	VIF amplifier input pin The input circuit is a balanced circuit, and the input impedance is as follows: $R\approx 1.0k\Omega$	17 18 18 11 11 11 11 11
19	GND		
20	RF AGC VR	RF AGC volume connection pin This pin sets the tuner RF AGC operating point. Also, the FM output and the video output can both be muted at the same time by connecting this pin to ground.	20 20
21	SIF CARRIER OUT	First SIF output pin This is an emitter-follower output with a 200Ω resistor attached in series.	-W-21 200Ω
22	AUDIO BIAS FILTER	Connection pin for a filter used to hold the FM detector output DC voltage fixed. Normally, a 1µF electrolytic capacitor should be used. The capacitance (CI) should be increased if the low band (around 50Hz) frequency characteristics need to be improved.	300Ω 40kΩ 40kΩ 40kΩ W W W W W W W W W W W W W W W W W W W

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Pin No.	Pin name	Function	Equivalent Circuit			
23	FILTER CONTROL C	Internal filter (trap) control pin Connect a capacitor with a capacitance between 0.47 to 1 μ F, depending on the video S/N as well as the levels of the AM and PM noise.	23			
24	AUDIO OUTPUT	Sound output pin Emitter follower output	24 - W- 1kΩ 777			

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